Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L9	277	(bond\$5 with pillar with (chip wafer die))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/17 07:32
L10	117	(bond\$5 with pillar with (chip wafer die) with pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/17 07:32
111	8	10 and visi	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/17 07:34
L12	164	9 and ("385"/\$.ccls. "257"/\$.ccls.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/17 07:35
L13	78	10 and ("385"/\$.ccls. "257"/\$.ccls.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/17 07:35
L14	70	13 not 11	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/17 07:36

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L15	47	("20020171177" "20030102566" "20030111727" "20030151167" "3777221" "5014161" "5291061" "5302778" "5435734" "5477082" "5477086" "5532519" "5535101" "5558271" "5559444" "5561328" "5719436" "5777345" "5790839" "5773320" "5777345" "5790839" "5793101" "5883814" "5900676" "5914535" "5973924" "5977640" "6064120" "6100593" "6150724" "6222246" "6232667" "6238949" "6239366" "6251488" "6259962" "6268584" "6310403" "6317333" "6376915" "6391251" "6392309" "6403882" "6524346" "6549821" "RE35119" "RE36613").PN. OR ("6984544"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/04/17 07:53
L16	2	("20050053319").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/17 08:01
S1	8	385/14.ccls. and \$5damascene	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:09
S2	183	385/14.ccls. and ((chip wafer substrate) with bond\$5 with pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/17 07:35
S3	183	385/14.ccls. and ((chip wafer substrate) with bond\$5 with pad with (chip wafer substrate))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:32
S4	19	S3 and vIsi	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:12

S5	4	385/14.ccls. and (bond\$5 with pillar)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:34
S6	10	385/14.ccis. and (bond\$5 with post)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:34
S7	8	S6 not S5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:34
S8	75	385/14.ccls. and (bond\$5 with (post pin))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:35
S9	0	S7 not (S4 S6 S1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:34
S10	61	S8 not (S4 S6 S1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:45
S11	17	385/14.ccls. and (bond\$5 with (post pin) with pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:44
S12	3403	(bond\$5 with (post pin pillar) with pad) with (chip wafer substrate die ic)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:45
S13	31	S12 and "385"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:57
S14	23	S13 not (S11 S4 S6 S1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 15:31

S15	269	S12 and (waveguide fiber fibre light\$2guide)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:58
S16	104	S12 and ((waveguide fiber fibre light\$2guide) with (chip wafer substrate die ic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 14:58
S17	80	S16 not (S14 S11 S4 S6 S1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 15:30
S18	5858	(pillar via) with bond\$5 with pad with (substrate chip wafer die)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 15:30
S19	48	(pillar via) with bond\$5 with pad with (substrate chip wafer die) with optic\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 15:30
S20	46	S19 not (S17 S11 S4 S6 S1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 15:55

LAST Search instory							
S21	179	("20020011663" "20020019305" "20020028045" "20020039464" "20020031297" "20020039464" "20030001240" "20030092243" "4422088" "4703993" "4711997" "4720634" "4732446" "4762382" "4774630" "4818045" "4838630" "4871224" "4912545" "4946253" "4966430" "5061027" "5100220" "5101460" "5130531" "5179609" "5198684" "5207631" "5237434" "5247597" "5337398" "5353498" "5420954" "5488681" "5499312" "5513021" "5533151" "5535296" "5631988" "5661831" "5675889" "5687267" "5692083" "5695933" "5790730" "5807783" "5812717" "5818107" "5854866" "5857049" "5900674" "5932387" "6046410" "6171887" "6236774" "6282352" "6293688" "6448168" "6517995").PN. OR ("5237434" "5638469" "6525407" "6741778" "6911392" "6935792").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2006/04/15 15:55	
S22	173	S21 not (S20 S17 S11 S4 S6 S1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 15:56	
S23	56	S22 and (bond\$5 with (pad pillar post))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 15:56	
S24	47	S23 and optic\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/15 15:56	